

SENIOR PARTNER | M.ENG, LL.B

KARMANYA SINGH SAREEN

Karmanya is a qualified electrical and electronics engineer. He is also an Advocate, enrolled with the Bar Council of India, while also being a registered Patent Agent and registered Trade Marks Agent. He co-founded Kommit and leads Kommit's patent prosecution, consulting and enforcement projects.

PROFESSIONAL EXPERIENCE

Senior Partner | Kommit Techno-Legal LLP

2020-present

- Co-founded and leads Kommit's consulting and prosecution practice.
- Manages several patent prosecution, consulting and commercialisation matters in India, USA, Europe and UAE.
- Leads the technical evaluation and analysis of several international patent enforcement campaigns valued between \$10m-\$100m.
- Specialises in circuit and chip design, IT, power systems, communication networks and semiconductor technology.
- Manages several trade mark and domain name disputes and enforcement projects for global clients in courts and before WIPO (UDRP).

Technology Consulting Analyst | Deloitte MCS Ltd. UK

2019-2020

- Implementation of SAP's enterprise resource planning solutions at organisations for streamlining of supply chain and logistics.
- Built the "to-be" process models for clients in order to analyse and implement a sustainable and seamless logistics and delivery setup.

EDUCATION

Bachelor of Laws (LL.B) | CCS University

Master of Engineering (M.Eng) | Imperial College London

Electrical and Electronic Engineering with Management

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NOTABLE ACHIEVEMENTS

Fellowship | Imperial College Union India-UK Achievers Honours | (Department of International Trade UK with the National Indian Students and Alumni Union UK (NISAU))

QUALIFICATIONS AND CERTIFICATIONS

Advocate | Bar Council of India
Qualified and registered Patent Agent | Indian Patent Office
Qualified and registered Trade Marks Agent | Indian Trade Mark Office
Cert-BA qualified | Chartered Institute of Management Accounting (CIMA)

PUBLICATIONS

K. Fobelets, K.S. Sareen, K. Thielemans | Magnetic coupling with 3D knitted helical coils, Volume 332, Part 2, 2021, 113213, ISSN 0924-4247, https://doi.org/10.1016/j.sna.2021.113213.

SKILLS

Hardware

Embedded systems, Energy systems, Wireless power transfer, Communication systems, Analogue and digital design

Software

C++, Python, ARM, Verilog, MATLAB

Intellectual Property

InPASS, Patent eFiling (India), IP.COM (patent module InnovationQ+), Espacenet, USPTO public search, WIPO PatentScope, WIPO ePCT